

	Hits	Search Text	DBs
1	128	((resist or photoresist or photoimageable) near16 (cut\$4 or dic\$5 or dice)) same laminat\$4 same (substrate or wafer or carrier or release))	US-PGPUB; USPAT
2	0	((resist or photoresist or photoimageable) near20 (fold\$5 near29 lead near22 edge)) same laminat\$4 same (substrate or wafer or carrier or release) same (sandwich or interpos\$4))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
3	1	((resist or photoresist or photoimageable) near20 (fold\$5 near29 lead near22 edge)) same laminat\$4 same (substrate or wafer or carrier or release))	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
4	1	((resist or photoresist or photoimageable) near20 (fold\$5 near29 lead near22 edge)) same (substrate or wafer or carrier or release)) and ((substrate or wafer or release or carrier) same (resist or photoresist or photoimageable) same laminat\$4)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
5	121	((resist or photoresist or photoimageable) same laminat\$4 same (substrate or wafer or carrier or release) same (expos\$4 or irradiat\$4 or illuminat\$4) same develop\$4 same curing)	US-PGPUB; USPAT